

Title (en)  
SENSOR MODULE AND METHOD FOR PRODUCING THE SENSOR MODULE

Title (de)  
SENSORMODUL UND VERFAHREN ZUR HERSTELLUNG DES SENSORMODULS

Title (fr)  
MODULE DÉTECTEUR ET SON PROCÉDÉ DE PRODUCTION

Publication  
**EP 2217887 A1 20100818 (DE)**

Application  
**EP 08853353 A 20081125**

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• DE 102007057904 A 20071129

Abstract (en)  
[origin: WO2009068508A1] The invention relates to a sensor module (1) having a sensor chip (2) mounted on a conductor mesh (4). A plastic sleeve (11) of the sensor module (1) extends solely over an edge area of the sensor chip (2). The mechanical load of the sensor chip (2) due to the plastic sleeve (11) is kept low.

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Citation (search report)  
See references of WO 2009068508A1

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